

# COMe 915 BASIC MODULES

# Com Express<sup>™</sup> Family

- → Intel<sup>®</sup> Pentium<sup>®</sup> M 1.4 GHz-2.0 GHz or Intel<sup>®</sup> Celeron<sup>®</sup> M 1.0 GHz
- → Intel<sup>®</sup> 915 GM Chipset with integrated Intel<sup>®</sup> Graphics Media Accelerator 900
- → Up to 1 GB PC2-4300 DDR2 SDRAM







# COMe 915 B Pentium M/Celeron M Basic Module



COM Express, an open specification of the PICMG (PCI Industrial Computer Manufacturer Group), is a module concept to bring PCI Express and other latest technologies like SATA, USB 2.0 and LVDS on a COM (Computer On Module).

COM Express is plugged onto an application-specific base board similar to the ETX concept, but offers more options and a growth path to future CPU technologies. Utilizing different sizes, COM Express can be used for highly embedded solutions up to high performance platforms.

The design of the COMe 915 B module supports the latest Pentium M/Celeron M technology on Intel's Embedded Roadmap with modern interfaces to PCI Express, SATA and Gbit LAN. A well-balanced price/performance ratio and a rich feature set are the perfect foundation to start with the COM Express technology in new designs and applications.

For evaluation and design-in of COM Express modules we provide evaluation baseboards to speed up your integration effort offering PC type connectors for simple access of all module interfaces.

Special Starter Kits for Linux are available on request.

#### **III** Features

- → Intel Pentium M 1.4 GHz-2.0 GHz or Intel Celeron M 1.0 GHz
- → Mobile Intel 915 GM Chipset with integrated Intel Graphics Media Accelerator (GMA) 900 or PCI Express Graphics multiplexed with two SDVO channels
- → Resolution up to 2.048 x 1.536
- $\rightarrow$  Up to 1 GB DDR2 (SO-DIMM, 533 MHz)
- → Two SATA-150 mass storage Interfaces
- → 10/100/1000 Base-TX Ethernet Interface
- → LVDS Interface (18 Bit, dual channel) Dual Independent Display supported
- → Four PCI Express x1 lanes
- → Eight USB 2.0 Interfaces
- → AC'97 Audio Interface
- → RTC (Battery-buffered)
- → System Monitoring, Watchdog
   → ACPI Power Management including suspend-to-RAM
- → Fully COM Express™ Type 2 compliant
- → Windows®XP (embedded) and Linux supported

Product description	Clock	TDP
COMe Celeron M ULV 373 Basic Module	1.00 GHz	16 Watt
COMe Pentium M 760 Basic Module	2.00 GHz	37 Watt
COMe Pentium M LV 738 Basic Module	1.40 GHz	20 Watt

## III Core Logic, Memory

CPU Intel Pentium M LV 738 (1.4 GHz, 400 MHz FSB)

or 760 (2.0 GHz, 533 MHz FSB)

or Celeron M ULV 373 1.0 GHz, 400 MHz FSB all versions soldered with optional heatspreader

Chipset Intel 82915GM, ICH6-M

Memory 200-pin SO-DIMM socket for up to 1 GB

DDR/DDR2 SDRAM (DDR 333; DDR2 400/533),

ECC possible with ECC-SODIMM

#### **III** Drives

EIDE One Enhanced IDE port ATA/UDMA100 Floppy External USB Floppy supported

## **III** Standard Interfaces

USB 8 x USB 2.0

#### **III** Bus Interfaces

COM Express Typ2 Interface with PCI and IDE support

Interface Three PCI Express x1 and one PCI Express x16 lane for

external graphics multiplexed with two SDVO channels

PCI 32-bit standard interface, 32bit @ 33 MHz

Serial Bus I<sup>2</sup>C Bus, SMBus interface

## **III** Flat Panel / CRT Interfaces

Graphics Controller Intel Graphics Media Accelerator (GMA) 900

(integrated in Intel 915GM Chipset)

Video Memory UMA, up to 32 MB

LCD Interface Dual channel LVDS 18-bit max. resolution 1.600 x 1.200

(1.920 x 1.200 for Wide Panels)

CRT Interface Max. resolution 2.048 x 1.536

#### **III** Miscellaneous

Watchdog Timer Creates system reset

(programmable, 0.4s, 1s, 5s, 1os, 3os, 1 min, 5 min

or 10 min)

Battery External

# **III** System Monitoring

Voltage yes Temperature yes

# **III** Sound Interface

Audio AC-Link for external AC'97-Codec

# **III** LAN Interface

Ethernet 10/100Base-T controller in ICH6-M + Intel® 82562EZ or

10/100/1000 Base-TX controller (Intel 82573) utilizing one

PCI Express x1 interface

LAN Boot RPL PXE

#### III BIOS

Type Phoenix cME FirstBios Embedded Pro (in on-board Flash)

Auto Plug & Play (PCI, ISA)

Configuration PCI Auto Configuration (PCI 2.1) Automatic DRAM

configuration

Boot Options Quick Boot, MultiBoot XP (FD, HD, CD, USB) Boot without

keyboard

Security System and setup password Write protection for BIOS Flash

GERMANY FRANCE USA U

#### **ELTEC** Elektronik AG

Galileo-Galilei-Strasse 11 55129 Mainz PO Box 10 03 64 55134 Mainz, Germany

Fon +49 6131 918 100 Fax +49 6131 918 195 Email info@eltec.com www eltec.com

#### **ELTEC** International SARL

1, Allée des Garays 91872 Palaiseau France

Fon +33 1 64 47 18 77
Fax +33 1 64 47 09 33
Email info.fr@eltec.com
www eltec-france.fr

#### American ELTEC, Inc.

Quail Park IV, Suite 57 2810 W. Charleston Avenue Las Vegas, Nevada 89102 IJSA

Fon +1 702 878 40 85 Fax +1 702 878 47 35 Email info.us@eltec.com www americaneltec.com

#### **ELTEC** International PLC

Unit 32, Stratford Office Village Wolverton Mill Milton Keynes MK12 5NS United Kingdom

Fon +44 1908 32 00 55 Fax +44 1908 31 01 07 Email info.uk@eltec.com www eltec.com

Power APM ACPI 2.0 compliant (including suspend-to-RAM)

Management Fixed frequency option (Setup) Geyserville 3 Support

USB USB support for Keyboard and Mouse
Video VGA Bios with flat panel extensions
Flash Update BIOS update via storage media
Setup CMOS setup backup in serial EEPROM

# **III** Power Supply

Power +12V +/-5% primary power supply

+5V +/-5% standby power supply

Power Consumption 20W typ. (1.4GHz, 256MB) 3W typ. (suspend S3)

## **III** Environment

Ambient  $0^{\circ} \dots 60^{\circ} \text{C}$  (operating) Temperature  $-25^{\circ} \dots 85^{\circ} \text{C}$  (storage) Humidity  $5 \dots 95^{\circ}$  (operating)

5 ... 95% (storage, non-cond.)

# III Mechanical

Dimensions 125 mm x 95 mm x 12 mm

Heatspreaders 125 mm x 95 mm x 2 mm with through hole

standoffs (3 mm)

or threaded corner standoffs (2.5mm)

